

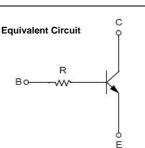
# FJY3011R NPN Epitaxial Silicon Transistor

# Features

- Switching circuit, Inverter, Interface circuit, Driver Circuit
- Built in bias Resistor (R=22KΩ)
- Complement to FJY4011R







July 2007

# Absolute Maximum Ratings \* T<sub>a</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units	
V <sub>CBO</sub>	Collector-Base Voltage	40	V	
V <sub>CEO</sub> Collector-Emitter Voltage		40	V	
V <sub>EBO</sub> Emitter-Base Voltage		5	V	
I <sub>C</sub>	Collector Current	100	mA	
T <sub>STG</sub> Storage Temperature Range		-55~150	°C	
TJ	Junction Temperature	150	۵°	
P <sub>C</sub>	Collector Power Dissipation, by $R_{\theta JA}$	200	00 mW	

These ratings are limiting values above which the serviceability of any semiconductor device may by impaired.

### Thermal Characteristics\* Ta=25°C unless otherwise noted

Symbol	Parameter	Мах	Units
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	600	°C/W

\* Minimum land pad size.

# Electrical Characteristics\* T<sub>C</sub> = 25°C unless otherwise noted

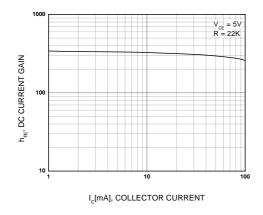
Symbol	Parameter	Test Condition	MIN	Тур	MAX	Units
V(BR)CBO	Collector-Emitter Breakdown Voltage	Ic = 100 uA, IE = 0	40			V
V(BR)CEO	Collector-Base Breakdown Voltage	Ic = 1mA, I <sub>B</sub> = 0	40			V
Ісво	Collector-Cutoff Current	Vcb = 30 V, IE = 0			0.1	uA
hfe	DC Current Gain	Vce = 5 V, Ic = 1 mA	100		600	
Vce(sat)	Collector-Emitter Saturation Voltage	Ic = 10 mA, I <sub>B</sub> = 1 mA			0.3	V
f⊤	Current Gain - Bandwidth Product	Vce = 10V, Ic = 5 mA		250		MHz
Ccb	Output Capacitance	V <sub>CB</sub> = 10 V, I <sub>E</sub> = 0, f = 1.0 MHz		3.7		pF
R	Input Resistor		15	22	29	KΩ

\* Pulse Test: PW≤300µs, Duty Cycle≤2%

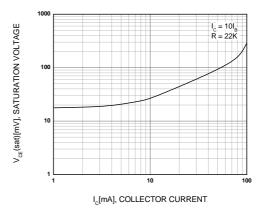
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# **Typical Performance Characteristics**

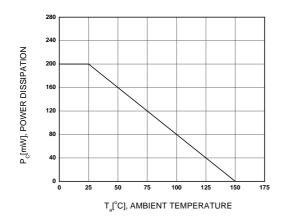
## Figure 1. DC current Gain

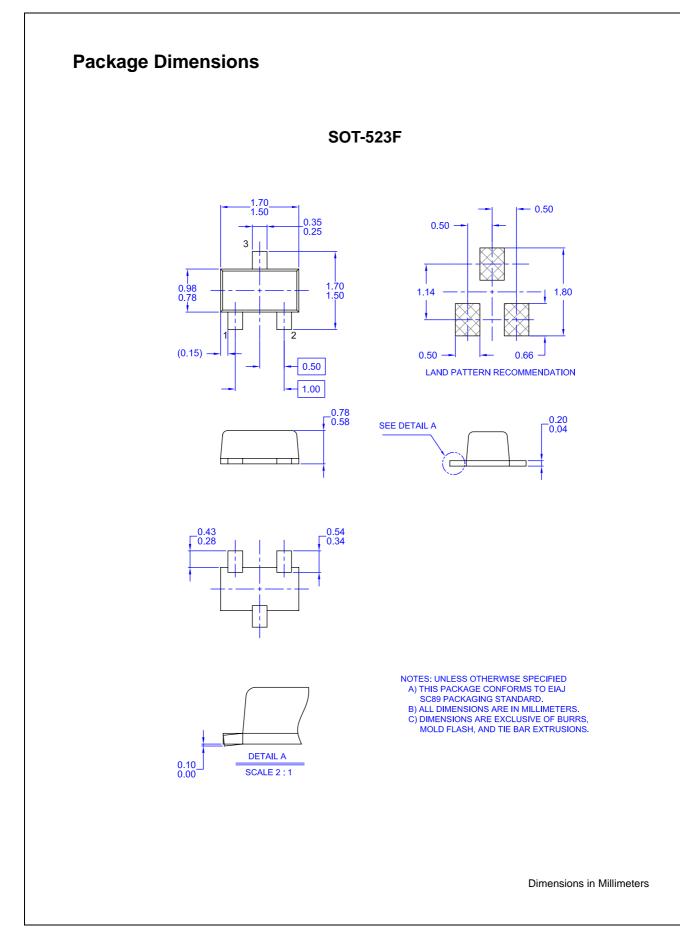


### Figure 2. Collector-Emitter Saturation Voltage



### Figure 3. Power Derating





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erTrench<sup>®</sup> rrammable Active Droop<sup>™</sup> T<sup>®</sup> Dptoelectronics<sup>™</sup> et Series<sup>™</sup> idConfigure<sup>™</sup> idConnect<sup>™</sup> larPump<sup>™</sup> ART START<sup>™</sup> ART START<sup>™</sup> ALTH<sup>™</sup> erFET<sup>™</sup> erFET<sup>™</sup> erSOT<sup>™</sup>-3 erSOT<sup>™</sup>-3 erSOT<sup>™</sup>-6 erSOT<sup>™</sup>-8 crFET<sup>™</sup> AT<sup>™</sup> Power Franchise<sup>®</sup>  $\label{eq:states} TinyBoost^{\mathsf{TM}} \\ TinyBuck^{\mathsf{TM}} \\ TinyLogic^{\textcircled{tmm}} \\ TINYOPTO^{\mathsf{TM}} \\ TinyPower^{\mathsf{TM}} \\ TinyWire^{\mathsf{TM}} \\ TruTranslation^{\mathsf{TM}} \\ \muSerDes^{\mathsf{TM}} \\ UHC^{\textcircled{tmm}} \\ UHC^{\textcircled{tmm}} \\ VCX^{\mathsf{TM}} \\ Wire^{\mathsf{TM}} \\ \end{array}$ 

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